New Product



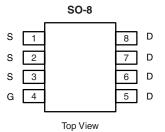
Si4196DY

ROHS COMPLIANT

Vishay Siliconix

N-Channel 20-V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A) ^{a, e}	Q _g (Typ.)		
	0.027 at V _{GS} = 4.5 V	8			
20	0.032 at V _{GS} = 2.5 V	8	8.3 nC		
	0.040 at V _{GS} = 1.8 V	8			



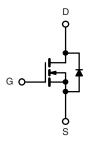
Ordering Information: Si4196DY-T1-E3 (Lead (Pb)-free)

FEATURES

- TrenchFET[®] Power MOSFET
- 100 % R_g Tested
- 100 % UIS Tested
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- DC/DC Converter
- Load Switches



N-Channel MOSFET

ABSOLUTE MAXIMUM RATING	S T _A = 25 °C, unles	ss otherwise no	ted		
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage		V _{DS}	20	V	
Gate-Source Voltage		V _{GS}	± 8		
	T _C = 25 °C		8 ^e		
Continuous Drain Current (T _{.1} = 150 °C)	T _C = 70 °C	L.	8 ^e		
Continuous Drain Current $(1_j = 150^{\circ} C)$	T _A = 25 °C	I _D	6.4 ^{b, c}		
	T _A = 70 °C		5.1 ^{b, c}		
Pulsed Drain Current		I _{DM}	20	— A	
Continuous Courses Durin Diada Current	T _C = 25 °C		3.8		
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	1.6 ^{b, c}		
Single Pulse Avalanche Current		I _{AS}	5		
Avalanche Energy L = 0.1 mH		E _{AS}	1.25	mJ	
	T _C = 25 °C		4.6		
Maximum Power Dissipation	T _C = 70 °C		2.9		
	T _A = 25 °C	P _D	2.0 ^{b, c}	- W	
	T _A = 70 °C		1.28 ^{b, c}	1	
Operating Junction and Storage Temperature R	T _J , T _{stg}	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS Typical Parameter Symbol Maximum Unit Maximum Junction-to-Ambient^{b,d} $t \le 10 s$ R_{thJA} 52 62.5 °C/W Maximum Junction-to-Foot (Drain) Steady State R_{thJF} 22 27

Notes:

a. Based on T_C = 25 °C.

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. Maximum under Steady State conditions is 110 °C/W.

e. Package limited.

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Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit	
Static				- 76-			
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	20			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$			21		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA		- 3.0			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	0.4		1.0	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 8 V$			± 100	nA	
<u> </u>	I _{DSS}	$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1	<u>† </u>	
Zero Gate Voltage Drain Current		$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 \text{ °C}$			10	μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 V, V_{GS} = 4.5 V$	10			A	
		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 8 \text{ A}$		0.021	0.027	+	
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 2.5 \text{ V}, \text{ I}_{D} = 5 \text{ A}$		0.025	0.032	Ω	
		V _{GS} = 1.8 V, I _D = 2.5 A		0.031	0.040	1	
Forward Transconductance ^a	g _{fs}	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 8 \text{ A}$		28		S	
Dynamic ^b					<u> </u>		
Input Capacitance	C _{iss}			830			
Output Capacitance	C _{oss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz		115		pF	
Reverse Transfer Capacitance	C _{rss}			63			
-		$V_{DS} = 10 \text{ V}, \text{ V}_{GS} = 8 \text{ V}, \text{ I}_{D} = 8 \text{ A}$		14.5	22	+	
Total Gate Charge	Qg			8.3	12.5	1	
Gate-Source Charge	Q _{gs}	V _{DS} = 10 V, V _{GS} = 4.5 V, I _D = 8 A		1.1		nC	
Gate-Drain Charge	Q _{gd}			1.1		1	
Gate Resistance	R _g	f = 1 MHz	0.6	3.0	6.0	Ω	
Turn-On Delay Time	t _{d(on)}			8	16		
Rise Time	t _r	$V_{DD} = 10 \text{ V}, \text{ R}_{\text{I}} = 2 \Omega$		13	25	- ns	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 5 \text{ A}, \text{ V}_{\text{GEN}} = 4.5 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$		33	60		
Fall Time	t _f	-		9	18		
Turn-On Delay Time	t _{d(on)}			5	10		
Rise Time	t _r	V_{DD} = 10 V, R_L = 2 Ω		12	24		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 5 \text{ A}, V_{GEN} = 8 \text{ V}, \text{ R}_g = 1 \Omega$		22	40		
Fall Time	t _f			8	16		
Drain-Source Body Diode Characteristi	cs						
Continuous Source-Drain Diode Current	۱ _S	T _C = 25 °C			3.8		
Pulse Diode Forward Current ^a	I _{SM}				20	A	
Body Diode Voltage	V _{SD}	I _S = 5.4 A		0.78	1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			11	22	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = 5.4 A, dl/dt = 100 A/μs, T _J = 25 °C		4	8	nC	
Reverse Recovery Fall Time	t _a			6			
Reverse Recovery Rise Time	t _b			5		ns	

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

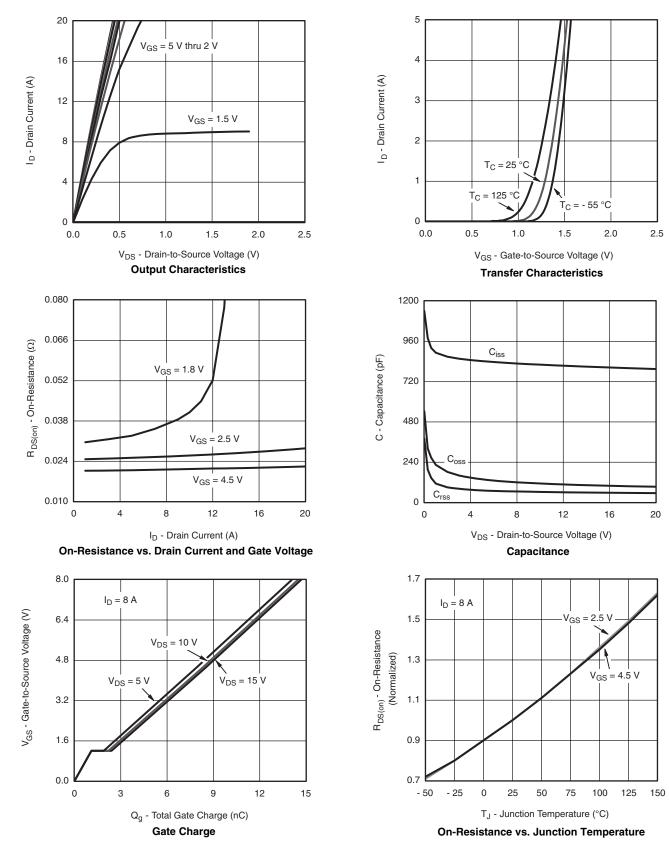
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



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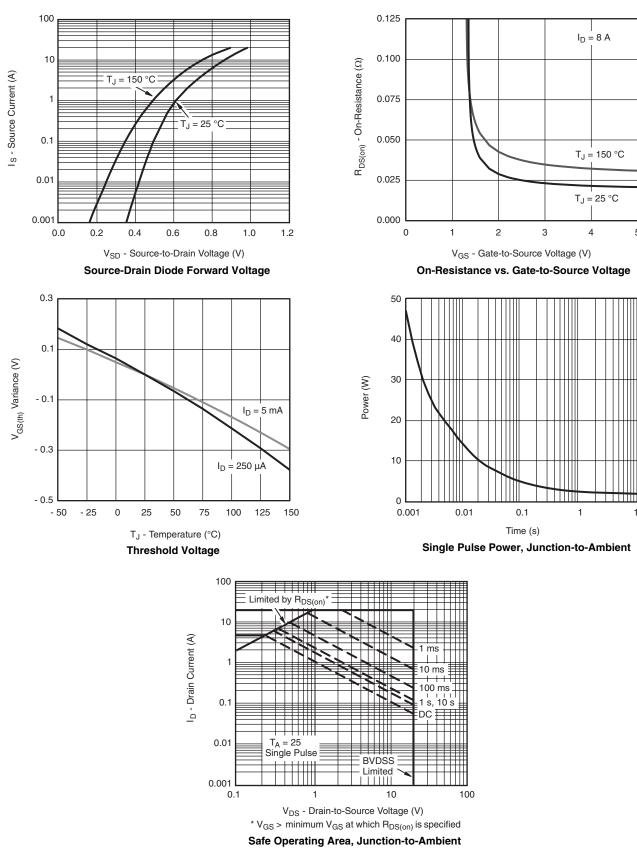
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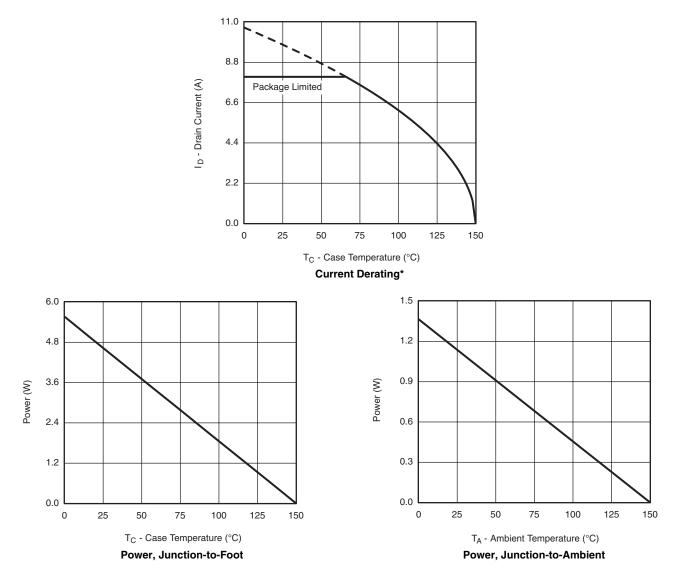
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Si4196DY Vishay Siliconix

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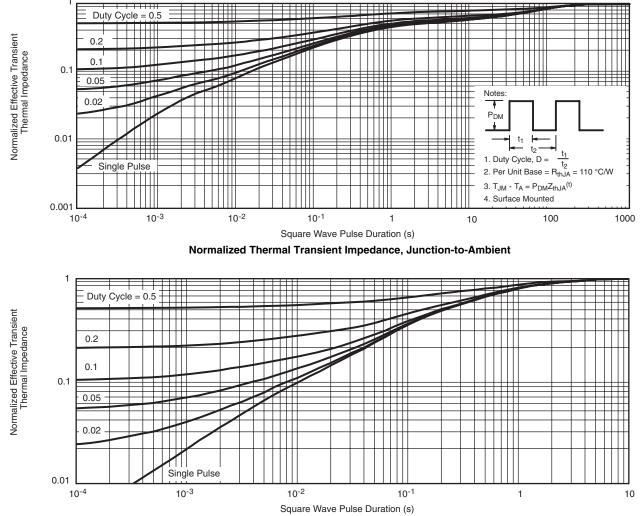


* The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?65534.



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